



Product Change Notification

Change Notification #: 116709 - 00
Change Title: Intel® Aero Development Platforms
INTEL® AERO READY TO FLY DRONE
INTEL® AERO COMPUTE BOARD
INTEL® AERO VISION ACCESSORY
KIT
INTEL® AERO ENCLOSURE KIT,
PCN 116709-00, Product Discontinuance,
End of Life
Date of Publication: January 15, 2019

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	February 15, 2019
Last Product Discontinuance Shipment Date:	May 15, 2019

Description of Change to the Customer:

Intel is discontinuing production of the below Intel® Aero Platform for UAVs:

- Ready to Fly drone (MM# 958536)
- Compute Board (MM# 958164)
- Vision Accessory Kit (MM# 953184)
- Enclosure Kit (MM# 953065)

Intel **is not** offering a replacement for the above products.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for these Discontinued Products and place your order, if any, in accordance with the Forecasted Key Milestones in this PCN. Customers must place their final order for Discontinued Product no later than February 15 2019. Customers must take delivery of all such orders no later than May 15, 2019.

Intel reserves the right to limit supply of Discontinued Product against any order booked after this PCN is published and Intel is without obligation to fulfill any order.

For questions about this Product Change Notice or the Discontinued Products contained in this Notice, please contact your local Intel Field Sales representative.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® Aero Enclosure Kit	82634DSARPLTVIK	953065
Intel® Aero Vision Accessory Kit	82634DSARPLTVAK	953184
Intel® Aero Compute Board	82634CRAPDVKC	958164
Intel® Aero Ready to Fly Drone	82634CRAPRTFC	958536

PCN Revision History:

Date of Revision:
January 15, 2019

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Japan Email: jccb.ijkk@intel.com

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